

## Features And Application

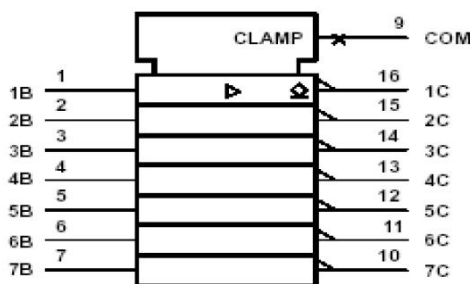
- 500-mA Rated Collector Current (Single Output)
- High-Voltage Outputs . . . 50 V
- Output Clamp Diodes
- Inputs Compatible With Various Types of Logic
- Relay Driver Applications

## Description

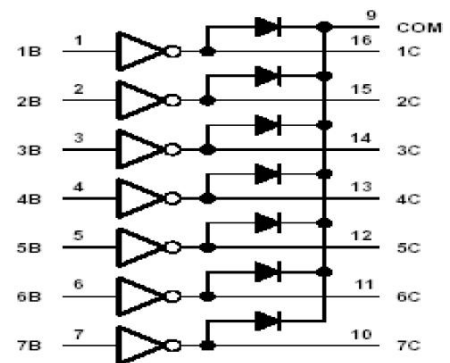
The CBM2003A are monolithic high-voltage, high-current Darlington transistor arrays. Each consists of seven n-p-n Darlington pairs that feature high-voltage outputs with common-cathode clamp diodes for switching inductive loads. The collector-current rating of a single Darlington pair is 500 mA. The Darlington pairs may be paralleled for higher current capability. Applications include relay drivers, hammer drivers, lamp drivers, display drivers (LED and gas discharge), line drivers, and logic buffers.

The CBM2003A has a 2.7-k $\Omega$  series base resistor for each Darlington pair for operation directly with TTL or 5-V CMOS devices.

### LOGIC SYMBOL



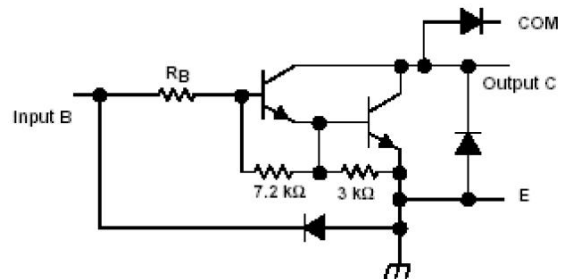
### LOGIC DIAGRAM



### SCHEMATICS (each Darlington Pair)

All resistor values shown are nominal.

**CBM2003A:  $R_B = 2.7\text{ k}\Omega$**



## Absolute Maximum Ratings (Ta =25°C)

Parameter	Symbol	Limit Values		Unit
		Min.	Max.	
Output Sustaining Voltage	$V_{CE(SUS)}$	-0.5	50	V
Output Current	$I_{OUT}$	500		mA/ch
Input Voltage	$V_{IN}$	- 0.5	30	V
Clamp Diode Reverse Voltage	$V_R$	50		V
Clamp Diode Forward Current	$I_F$	500		mA
Power Dissipation	DIP	$P_D$	1.15	W
	SOP		0.95	
Operating Temperature	$T_{opr}$	-40	85	°C
Storage Temperature	$T_{stg}$	-55	150	°C

\* Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied.

Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## Recommended Operating Conditions(Ta= -40~85°C)

Parameter	Symbol	Test Condition	Limit Value		Unit		
			Min	Max			
Output Sustaining Voltage	$V_{CE(SUS)}$		0	50	V		
Output Current	DIP	$I_{OUT}$	TPW=25ms,Duty=10%, 7 Circuits	0	370	mA/ch	
			TPW=25ms,Duty=30%, 7 Circuits	0	200		
			SOP	TPW=25ms,Duty=10%, 7 Circuits	0		390
				TPW=25ms,Duty=30%, 7 Circuits	0		150
Input Voltage	$V_{IN}$		0	3.	V		
Clamp Diode Reverse Voltage	$V_R$			50	V		
Clamp Diode Forward Current	$I_F$			400	mA		
Power Dissipation	DIP	$P_D$		0.52	W		
	SOP			0.4			

### Electrical Characteristics , $T_a = 25^{\circ}\text{C}$ (unless otherwise noted)

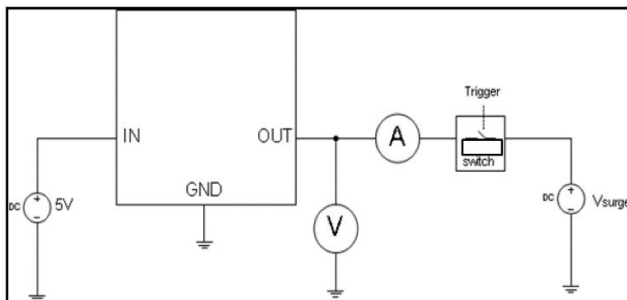
Parameter	Test Fig.	Test Conditions	Min	Typ	Max	Unit	
$V_{I(on)}$ On-state Input Voltage	6	$V_{CE}=2\text{V}$	$I_C=125\text{mA}$				V
			$I_C=200\text{mA}$			2.4	
			$I_C=250\text{mA}$			2.7	
			$I_C=275\text{mA}$				
			$I_C=300\text{mA}$			3	
			$I_C=350\text{mA}$				
$V_{CE(sat)}$ Collector-emitter saturation voltage	5	$I_I=250\mu\text{A}$	$I_C=100\text{mA}$		0.9	1.1	V
		$I_I=350\mu\text{A}$	$I_C=200\text{mA}$		1	1.3	
		$I_I=500\mu\text{A}$	$I_C=350\text{mA}$		1.2	1.6	
$I_{CEX}$ Collector outoff current	1	$V_{CE}=50\text{V}$	$I_I=0$			50	uA
	2	$V_{CE}=50\text{V}$ , $T_A=85^{\circ}\text{C}$	$I_I=0$ $V_I=1\text{V}$			100	
$h_{FE}$ DC Current Transfer Ratio	5	$V_{CE}=2\text{V}$ , $I_{OUT}=350\text{mA}$	1000				
$V_F$ Clamp forward voltage	8	$I_F=350\text{mA}$		1.7	2	V	
$I_{I(off)}$ Off-state input current	3	$V_{CE}=50\text{V}$ , $T_A=85^{\circ}\text{C}$	$I_C=500\mu\text{A}$	50	65		uA
$I_I$ Input current	4	$V_I=2.4\text{V}$			0.4	0.7	mA
		$V_I=5\text{V}$					
		$V_I=12\text{V}$					
$I_R$ Clamp reverse current	7	$V_R=50\text{V}$				50	uA
		$V_R=50\text{V}$ , $T_A=85^{\circ}\text{C}$				100	
$C_I$ Input capacitance		$V_I=0$ , $f=1\text{MHz}$		15	25	pF	

### Switching Characteristics, $T_A=25^{\circ}\text{C}$

Parameter	Test Conditions	Min	Typ	Max	Unit
$t_{PLH}$ Propagation delay time, low-to-high-level output	See Figure 9		0.25	1	us
$t_{PHL}$ Propagation delay time, high -to- low -level output			0.25	1	us
$V_{OH}$ High-level output voltage after switching	$V_S=50\text{V}$ , $I_O=300\text{mA}$ , See Figure 10	$V_S-20$			mV

\* EOS (Electrical Over Stress) Immunity Level

## Test Circuit



Test conditions	
VCC	12V
Power on time	5000ms
Current max	1.0A
IN	pin4
OUT	pin13

tE (Endurance time) : time until IC damage / Criterion : IC should survive EOS

EOS Immunity Level: More than 5000ms

## PARAMETER MEASUREMENT INFORMATION

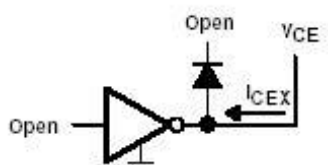


Figure 1.  $I_{CEX}$  Test Circuit

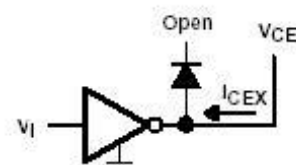


Figure 2.  $I_{CEX}$  Test Circuit

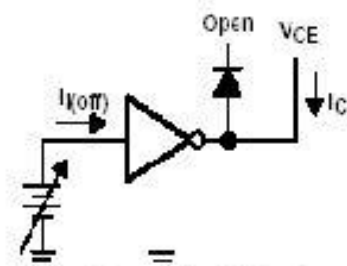


Figure 3.  $I_{I(off)}$  Test Circuit

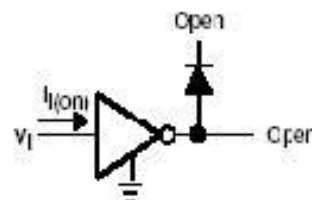
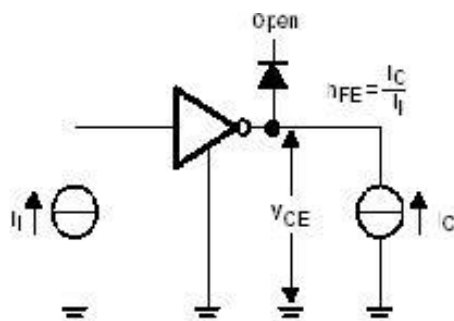


Figure 4.  $I_I$  Test Circuit



NOTE:  $I_I$  is fixed for measuring  $V_{CE(sat)}$ , variable for measuring  $h_{FE}$ .

Figure 5.  $h_{FE}$   $V_{CE(sat)}$  Test Circuit

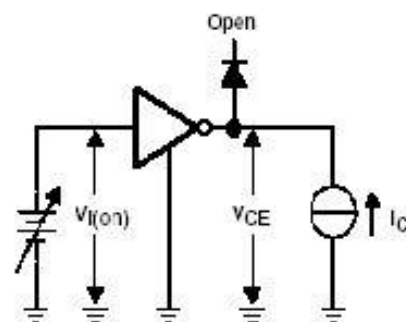


Figure 6.  $V_{I(on)}$  Test Circuit

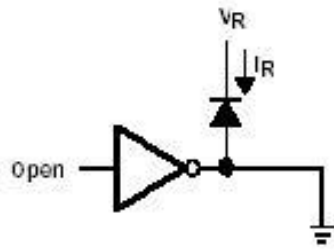


Figure 7.  $I_R$  Test Circuit

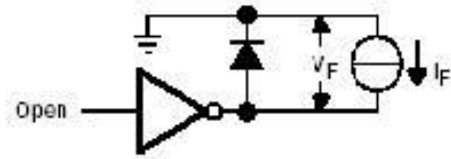


Figure 8.  $V_F$  Test Circuit

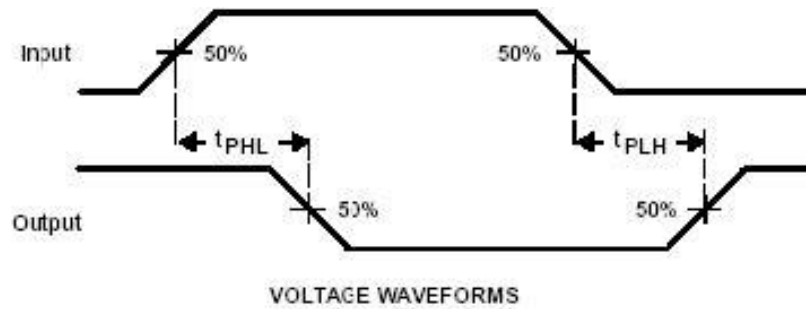


Figure 9. Propagation Delay-Time Waveforms

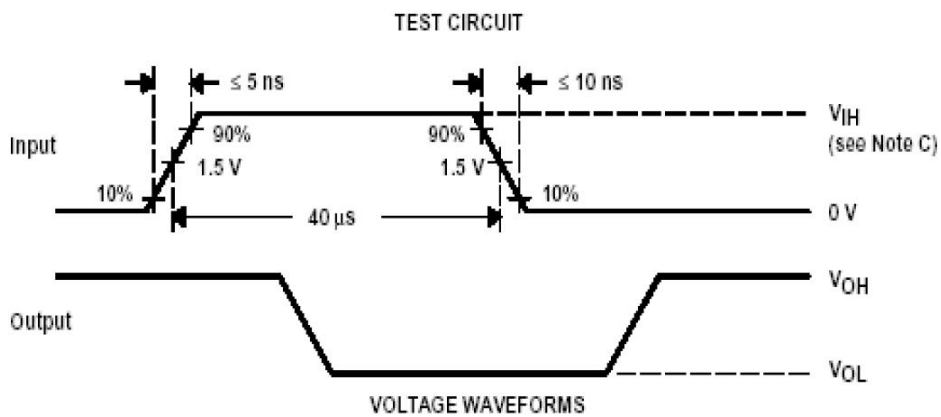


Figure 10. Latch-Up Test Circuit and Voltage Waveforms

- NOTES:** A. The pulse generator has the following characteristics: PRR = 12.5 kHz,  $Z_O=50$ .  
 B. CL includes probe and jig capacitance.  
 C.  $V_{IH} = 3\text{ V}$ ;

## TYPICAL CHARACTERISTICS

COLLECTOR-EMITTER  
SATURATION VOLTAGE  
VS  
COLLECTOR CURRENT  
(ONE DARLINGTON)

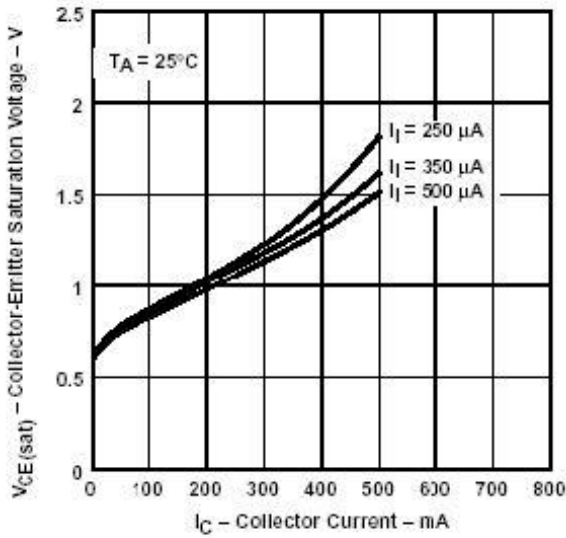


Figure 11

COLLECTOR-EMITTER  
SATURATION VOLTAGE  
VS  
TOTAL COLLECTOR CURRENT  
TWO DARLINGTONS PARALLELED

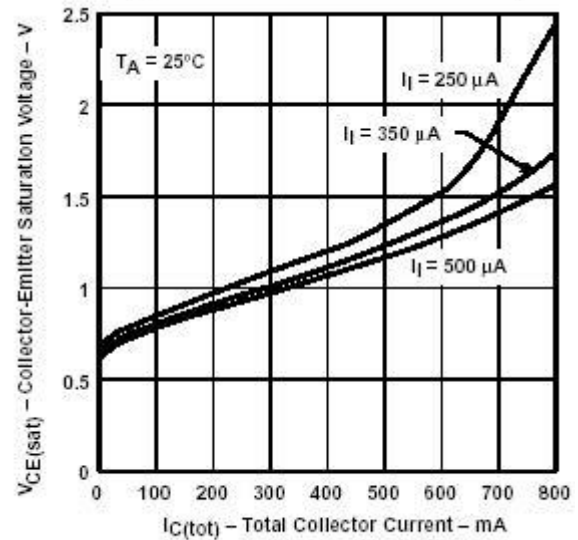


Figure 12

COLLECTOR CURRENT  
VS  
INPUT CURRENT

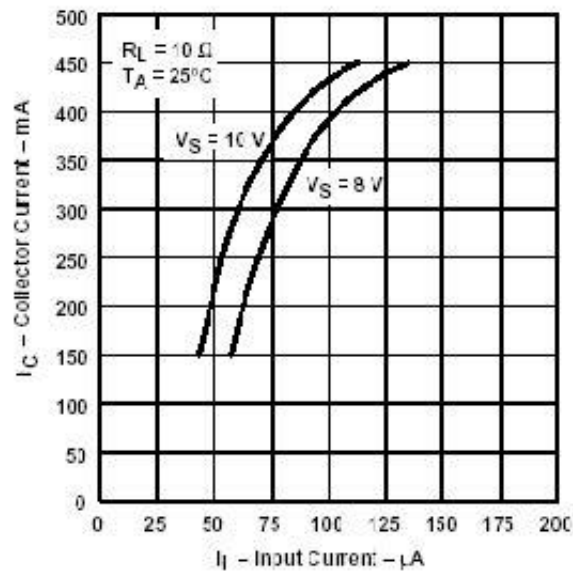


Figure 13

## THERMAL INFORMATION

**D PACKAGE**  
**MAXIMUM COLLECTOR CURRENT**  
**Vs**  
**DUTY CYCLE**

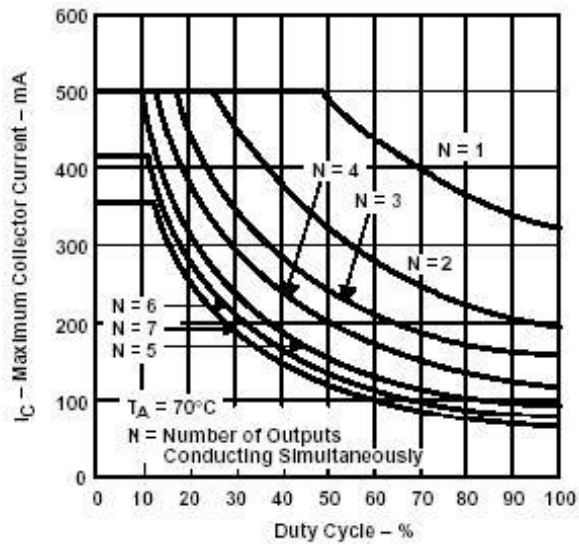


Figure 14

**N PACKAGE**  
**MAXIMUM COLLECTOR CURRENT**  
**Vs**  
**DUTY CYCLE**

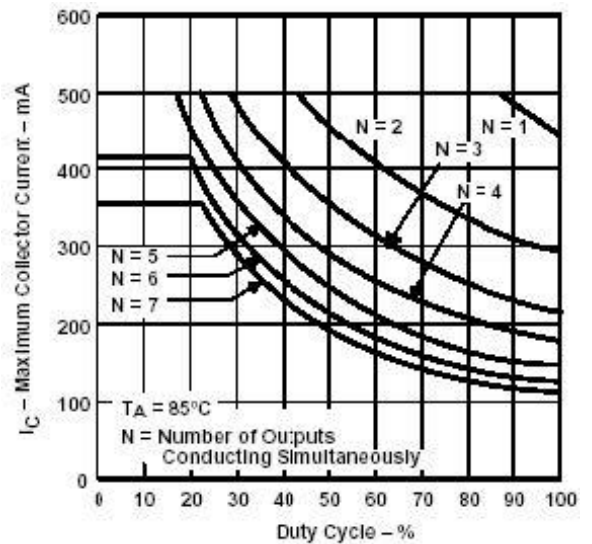
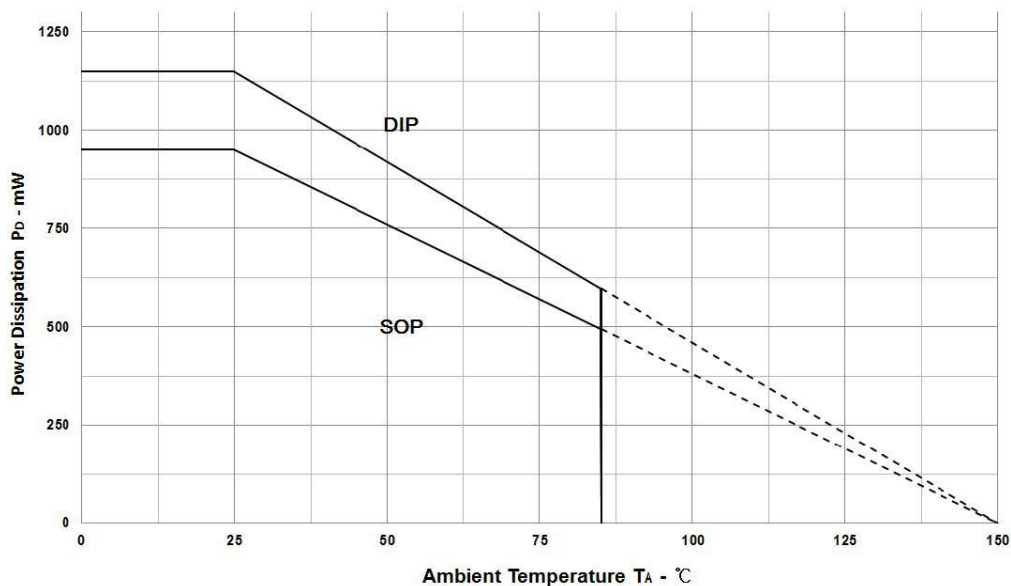


Figure 15

**POWER DISSIPATION**  
**VS.**  
**AMBIENT TEMPERATURE**



APPLICATION INFORMATION

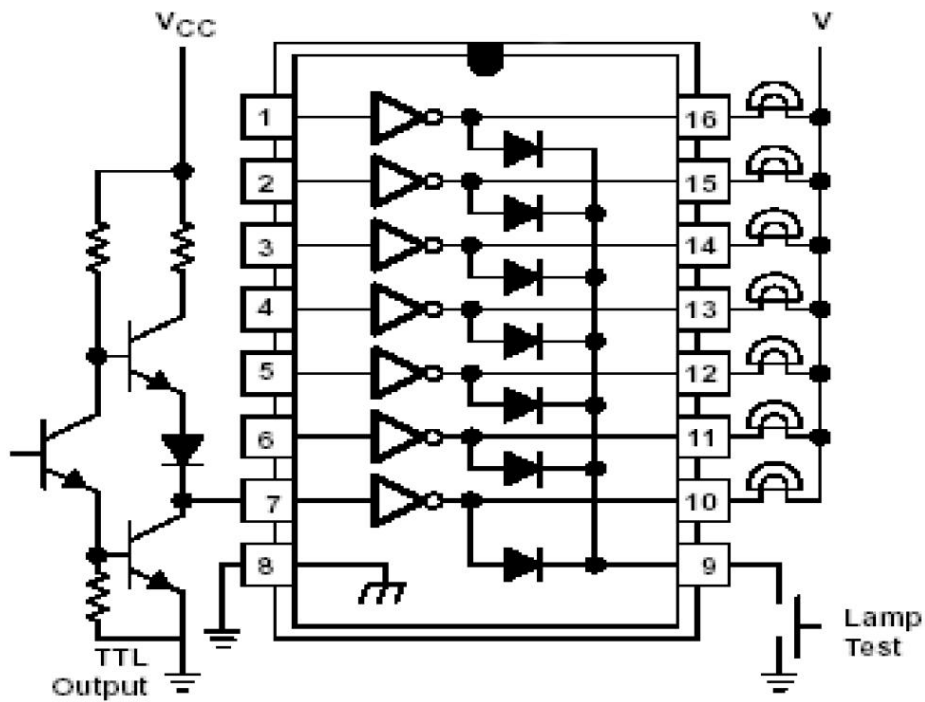


Figure 16. TTL to Load

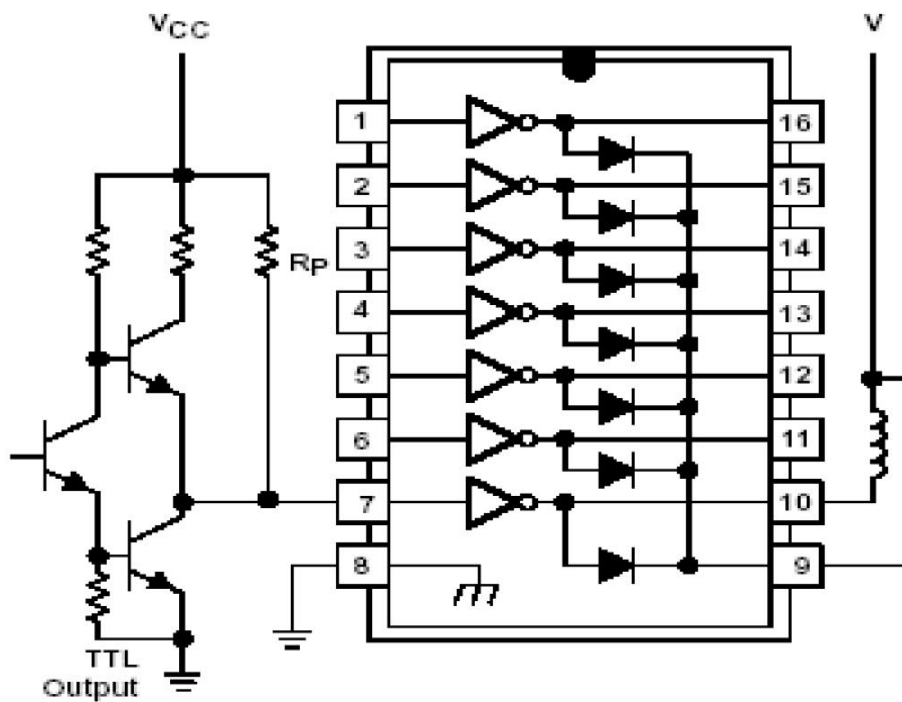
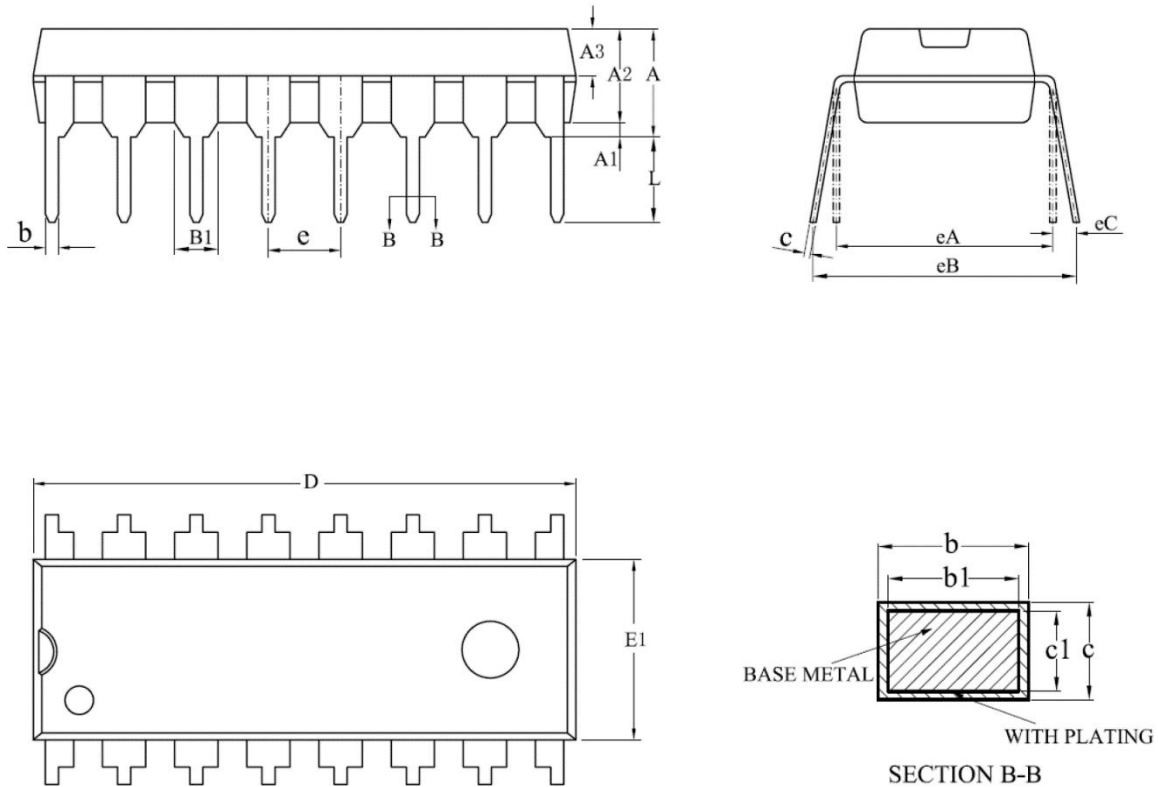


Figure 17. Use of Pullup Resistors to Increase Drive Current



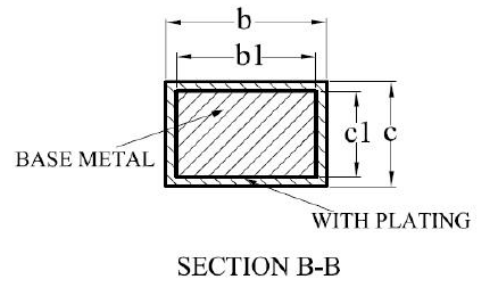
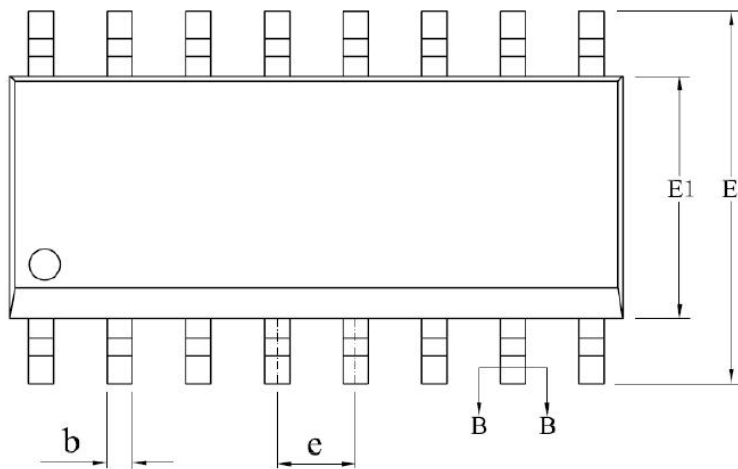
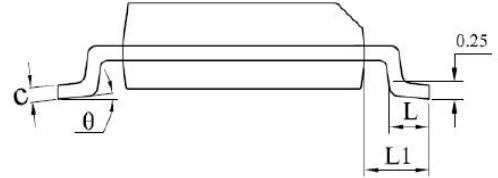
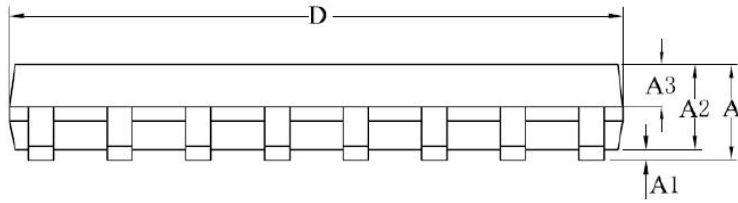
## Package Dimensions

### DIP-16



SYMBOL	MILLIMETER			SYMBOL	MILLIMETER		
	MIN	NOM	MAX		MIN	NOM	MAX
A	3.60	3.80	4.00	c1	0.24	0.25	0.26
A1	0.51			D	18.90	19.10	19.30
A2	3.10	3.30	3.50	E1	6.15	6.35	6.55
A3	1.42	1.52	1.62	e	2.54 BSC		
b	0.44		0.53	eA	7.62 BSC		
b1	0.43	0.46	0.48	eB	7.62		9.50
B1	1.52 BSC			eC	0		0.94
c	0.25		0.31	L	3.00		
L/F 载体尺寸 (Mil)	80×80						
	110×140						
	140×170						

SOP-16



SYMBOL	MILLIMETER			SYMBOL	MILLIMETER		
	MIN	NOM	MAX		MIN	NOM	MAX
A			1.75	D	9.70	9.90	10.10
A1	0.10		0.25	E	5.80	6.00	6.20
A2	1.35	1.40	1.45	E1	3.70	3.90	4.10
A3	0.60	0.65	0.70	e	1.27 BSC		
b	0.39		0.48	L	0.50		0.80
b1	0.38	0.41	0.43	L1	1.05 BSC		
c	0.21		0.26	$\theta$	0°		8°
c1	0.19	0.20	0.21				
L/F 载体尺寸 (Mil)	75×75						
	90×110						
	70×180						

## PACKAGE/ORDERING INFORMATION

PRODUCT	ORDERING	TEMPRANGE	PACKAGE	PAKEAGE	TRANSPOT
CBM2003	CBM2003AS	-40°C~85°C	SOP-16	CBM2003A	Tape and Reel,2500
CBM2003	CBM2003AIP	-40°C~85°C	DIP-16	CBM2003AIP	Tape and Reel,50